Vishay General Semiconductor

Fast Avalanche SMD Rectifier



DO-214AC (SMA)

1.5 A

800 V, 1000 V

30 A

1.0 µA

1.6 V

120 ns

20 mJ

150 °C

PRIMARY CHARACTERISTICS

I_{F(AV)}

V_{RRM}

I_{FSM}

 I_{R}

 V_{F}

t_{rr}

 E_R

T_{.1} max.

FEATURES

- Low profile package
- Ideal for automated placement
- · Glass passivated junction
- · Low reverse current
- Soft recovery characteristic
- · Fast reverse recovery time
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Solder dip 260 °C, 40 s
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC

TYPICAL APPLICATIONS

For use in fast switching rectification of power supply, inverters, converters and freewheeling diodes for consumer, automotive and telecommunication.

MECHANICAL DATA

Case: DO-214AC (SMA)

Epoxy meets UL 94V-0 flammability rating

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD22-B102

E3 suffix for consumer grade, meets JESD 201 class 1A whisker test, HE3 suffix for high reliability grade (AEC Q101 qualified), meets JESD 201 class 2 whisker test

Polarity: Color band denotes the cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)						
PARAMETER	SYMBOL	BYG21K	BYG21M	UNIT		
Device marking code		BYG21K	BYG21M			
Maximum repetitive peak reverse voltage	V _{RRM}	800	1000	V		
Average forward current	I _{F(AV)}	1.5		А		
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}	30		А		
Pulse energy in avalanche mode, non repetitive (inductive load switch off) $I_{(BR)R} = 1 \text{ A}, T_J = 25 \text{ °C}$	E _R	20		mJ		
Operating junction and storage temperature range	T _J , T _{STG}	- 55 to + 150 °		°C		



RoHS COMPLIANT



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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	BYG21K	BYG21M	UNIT
Maximum instantaneous forward voltage ⁽¹⁾	l _F = 1 A l _F = 1.5 A	T _J = 25 °C	V _F	1. 1.		V
Maximum reverse current	$V_{R} = V_{RRM}$	T _J = 25 °C T _J = 100 °C	I _R	1 10		μA
Maximum reverse recovery time	$I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A}, I_{rr} = 0.25 \text{ A}$		t _{rr}	120		ns

Note:

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

THERMAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise noted)					
PARAMETER	SYMBOL	. BYG21K BYG21M		UNIT	
Typical thermal resistance, junction to lead $T_L = const.$	$R_{\theta JL}$	25		°C/W	
Typical thermal resistance, junction to ambient	$R_{ hetaJA}$	150 ⁽¹⁾ 125 ⁽²⁾ 100 ⁽³⁾		°C/W	

Notes:

(1) Mounted on epoxy-glass hard tissue

(2) Mounted on epoxy-glass hard tissue, 50 mm² 35 μ m Cu

(3) Mounted on Al-oxide-ceramic (Al_2O_3), 50 mm² 35 μ m Cu

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PACKAGE CODE	BASE Q'TY	DELIVERY MODE	
BYG21K-E3/TR	0.064	TR	1800	7" diameter plastic tape and reel	
BYG21K-E3/TR3	0.064	TR3	7500	13" diameter plastic tape and reel	
BYG21KHE3/TR ⁽¹⁾	0.064	TR	1800	7" diameter plastic tape and reel	
BYG21KHE3/TR3 ⁽¹⁾	0.064	TR3	7500	13" diameter plastic tape and reel	

Note:

(1) Automotive grade AEC Q101 qualified

RATINGS AND CHARACTERISTICS CURVES

(T_A = 25 °C unless otherwise noted)

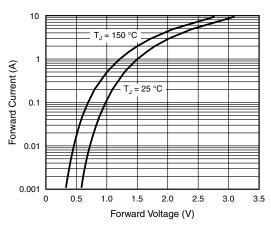


Figure 1. Forward Current vs. Forward Voltage

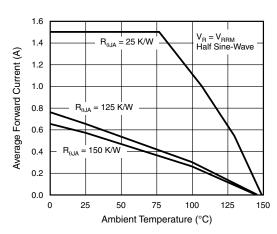


Figure 2. Max. Average Forward Current vs. Ambient Temperature



BYG21K & BYG21M

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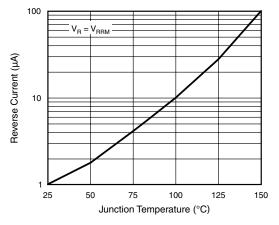


Figure 3. Reverse Current vs. Junction Temperature

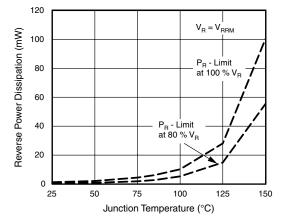


Figure 4. Max. Reverse Power Dissipation vs. Junction Temperature

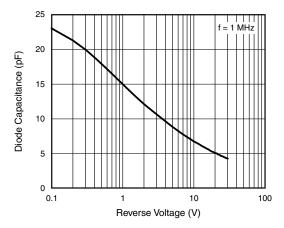


Figure 5. Diode Capacitance vs. Reverse Voltage

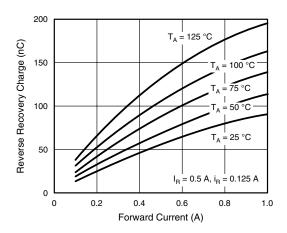


Figure 6. Max. Reverse Recovery Charge vs. Forward Current

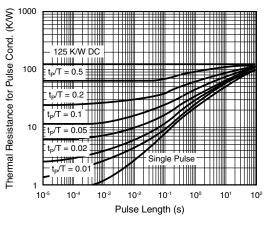


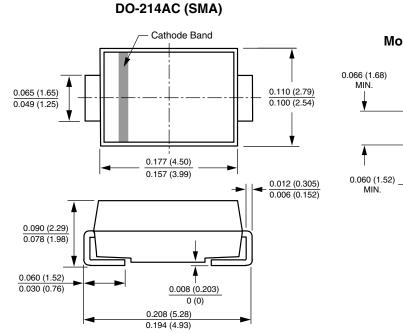
Figure 7. Thermal Response

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0.074 (1.88) MAX.

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)



Mounting Pad Layout

0.208 (5.28) REF.



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